

Silicon N Channel Power MOSFET

Description

The HXN0608 is n-channel power trench MOSFET with latest technology. So fast switching speed and low on-resistance. Usually used at power switching application . It is also intended for any applications with low gate drive requirements .

Features

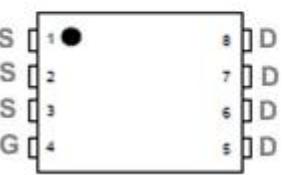
- Latest Trench Power MOSFET technology
- Low On-state Resistance
- High Current Density
- Low Gate Charge
- 100% UIS Test

Product Summary

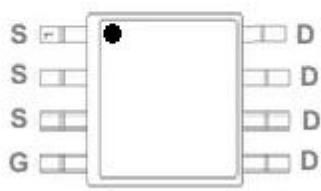
BVDS	RDS(on)	ID
60V	15mΩ	8A

Applications

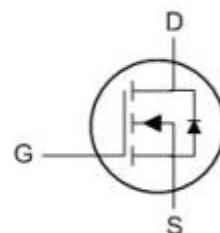
- Power Management
- Motor Driver



DFN5*6



SOP8



Silicon N Channel Power MOSFET**1. Absolute maximum ratings**

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage (V _{GS} = 0)	60	V
V _{GS}	Gate-source voltage	±20	V
I _D ⁽¹⁾	Drain current (continuous) at TC = 25 °C	8	A
I _{DM} ⁽²⁾	Drain current (pulsed)	32	A
P _D	Power dissipation at TC = 25 °C	2.0	W
E _{AS} ⁽³⁾	Single pulse avalanche energy	150	mJ
T _j	Operating junction temperature	-55 to 150	°C

1. Current limited by package
2. Pulse width limited by safe operating area
3. Starting T_j= 25 °C, I_D= 18A, V_{DD}= 30V, L=1mH

2. Thermal data

Symbol	Parameter	Min.	Typ.	Max.	Unit
R _{θJA}	Thermal Resistance Junction-Ambient		60		°C/W
R _{θJC}	Thermal Resistance Junction-Case		20		°C/W

3. Electrical characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown	I _D =250 μA, V _{GS} = 0	60			V
I _{DSS}	Zero gate voltage drain	V _{DS} =Max rating			1	μA
I _{GSS}	Gate body leakage current	V _{GS} = ±20V			±100	nA
V _{GS(th)}	Gate threshold voltage	V _{DS} = V _{GS}	1	1.3	2.5	V
R _{DS(on)}	Static drain-source on	V _{GS} = 10V , Id=8A		10	12	mΩ
R _{DS(on)}	Static drain-source on	V _{GS} = 4.5V , Id=6A		12	15	mΩ

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C_{iss}	Input capacitance	$V_{DS} = 25V$	3000		pF
C_{oss}	Output capacitance	$f = 1 \text{ MHz}$	230		pF
C_{rss}	Reverse transfer	$V_{GS} = 0$	170		pF
Q_g	Total gate charge	$V_{DD} = 30V$	30		nC
Q_{gs}	Gate-source charge	$I_D = 40A$	12		nC
Q_{gd}	Gate-drain charge	$V_{GS} = 10V$	9		nC
I_{SD}	Source-drain current			50	A
$I_{SDM}^{(1)}$	Source-drain current (pulsed)			200	A
$V_{SD}^{(2)}$	Forward on voltage	$I_{SD} = 8A, V_{GS} = 0$		1.2	V

1. Pulse width limited by safe operating area
2. Pulsed: pulse duration=300 μs , duty cycle 1.5%